



PATENT APPLICATION
Docket No.: 45475-00028
99-44653

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of: Sung Sik Jang

For: SEMICONDUCTOR PACKAGE HAVING IMPROVED ADHESIVENESS AND GROUND BONDING

BOX PATENT APPLICATION Assistant Commissioner of Patents Washington, D.C. 20231

Sir:

PATENT APPLICATION TRANSMITTAL LETTER

Transmitted herewith for filing, please find the following:

- (XX) The specification of the above-referenced patent application is enclosed herewith (<u>16</u> page(s) including claim(s) and Abstract).



3. (X) The fees for this application have been calculated and included as shown below (Prior to calculating the fees, please enter any enclosed preliminary amendment.):

	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$710
TOTAL CLAIMS	20-20	0	\$80	0
INDEPENDENT CLAIMS	3-3	0	\$80	0
MULTIPLE DEPENDENT CLAIM(S) PRESENTED				
TOTAL FEES:				\$710.00
Deduct One-Half	for Small Entity	Status	•	
Assignment Recordal Fee \$40				
TOTAL AMOUNT DUE:				\$710.00

4	Please charge	the amount of \$ is/are enclosed herewith. any deficiency or credit any overpayment to Deposit
	of \$	charge my Deposit Account No in the amount Please charge any deficiency or credit any yment to Deposit Account No
5. (X)	Unsign Newly A cop applic signat	eclaration is enclosed herewith that is: ed executed per 37 CFR 1.63(a) and (b). y of the executed declaration filed in the prior ation upon which priority is based, showing the ure or an indication thereon that it was signed; and: This application is being filed fewer than all of the inventors named in the prior application and it is requested that the following name or names be deleted from the list of inventors in the prior application for this continuation or divisional application:
		The prior application was accorded status under 37 CFR § 1.47 and is accompanied by: A copy of the decision granting a petition to accord Sec. 1.47 status to the prior application

	<pre>(unless all of the inventors have or legal representatives have filed an oath or declaration to join in the prior application). A copy of the subsequently executed oath(s) or declaration(s) filed by the inventor(s) or legal representative(s) that have subsequently joined in the prior application.</pre>	
6. (X)	The power of attorney for this application: is appointed in the newly executed Oath or Declaration submitted herewith. X is appointed by the power of attorney enclosed herewith. remains the same as originally in the parent application. was changed during the prosecution of the parent application and a copy of the change in the power of attorney is enclosed herewith.	
7. (XX)	The correspondence address for this application shall be: Stanley R. Moore, Esq. Jenkens and Gilchrist, P.C. 3200 Fountain Place 1445 Ross Ave. Dallas, Texas 75202 X which is a new correspondence address or a change therein. which is the same as originally in the parent application.	
	which is the change in the correspondence address that was filed during the prosecution of the parent application.	
8. (XX)	Priority is hereby claimed under 35 USC 119 and 172 to the following foreign applications:	
	Country Serial No. Date Korea 99-44653 Oct. 15, 1999	
	and: A certified copy of each application is enclosed herewith. A certified copy of each application was filed in prior application Serial No	
9. ()	A verified statement claiming small entity status under 37 CFR 1.9 and 1.27: is enclosed herewith. was filed in parent application Serial No, and such status remains unchanged and is requested for this application.	
10. ()	A preliminary amendment is enclosed herewith.	
11. ()	An Information Disclosure Statement with Modified PTO Form 1449 and a copy of the cited references are enclosed herewith.	

12. ()	An Assignment of the invention to with cover sheet and recordation fee is enclosed herewith for recordation by the Assignment Branch.
13. ()	The Commissioner is hereby authorized to charge payment, or to credit any overpayment, of the following fees associated with this filing or during the pendency of this application to Deposit Account No. Any patent application filing fees under 37 CFR 1.16. Any patent application processing fees under 37 CFR 1.17. The issue fee under 37 CFR 1.18 at or before mailing of the Notice of Allowance, pursuant to 37 CFR 1.311(b).
14. ()	Other (specify):
15. (XX)	Confirmation Postcard.

Respectfully submitted,

Stanley R. Moore Reg. No.26,958

Jenkens & Gilchrist, P.C. 3200 Fountain Place 1445 Ross Avenue Dallas, Texas 75202-2799 214/855-4713 214/855-4300 (Fax)